

TPC-B300

Modular TPC - Computing Box Module with Intel Elkhart Lake Atom and Celeron



Features

- Computing Box powered by Intel® Atom™ X6425E/Celeron® J6412 with DDR4 SODIMM slot (up to 32GB)
- Multiple sized front panel module offering with P-Cap multi-touch sensor (12.1" & 19" w/ robust 5-wire resistive touch)
- 1 x Full-size mini PCIe for iDoor expansion
- 1 x M.2 Key-E 2230 for WIFI + BT module
- 1 x M.2 Key-M 2280 for NVMe SSD
- 1 x 2.5" SATA SSD expansion
- 2 x 2.5Gb LAN
- Supports TPM2.0 hardware security
- Wide Temp Support. Range -20~60 °C (Atom™ X6425E)

Introduction

TPC-B300 computing box modules are powered by Intel® Atom™ X6425E/Celeron® J6412 Processors to provide compact and fanless control panel solutions that deliver high-performance computing. With a highly flexible modular design, TPC-B300 allows users to change the panel sizes (12"-23.8").

Specifications

General

- **Certification** CE, FCC Class A, CB/UL
- **Cooling System** Fanless design
- **Dimensions (W x H x D)** 269 x 203 x 30 (mm)
- **Enclosure** Metal
- **Mounting** VESA Mount, Desktop, Wall or Panel Mount (FPM-Display and Mounting kit support)
- **OS Support** Windows 10 IoT Enterprise LTSC
- **Power Input** 24 V_{DC} ± 20%
- **Weight (Net)** 2.1 kg (4.6 lbs)

System Hardware

- **CPU** Intel® Elkhart Lake Atom™ x6425E 2.00 GHz, quad core Celeron® J6412 2.00 GHz, quad core
- **Memory** 1 x DDR4 SO-DIMM slot (up to 32GB)
- **Storage** 1 x M.2 M key 2280 (SATA/PCIE) 1 x 2.5" SSD/HDD
- **LAN** 2 x Intel® I226; 2.5GbE
- **Expansion Slot** 1 x Full-size mini PCIe (PCIE/USB2.0) *Support iDoor module / 4G&5G LTE SIM slot
- **I/O** 1 x M.2 AE key 2230 (PCIE/USB2.0) 2 x RS-232/422/485 3 x USB 3.2 1 x USB 2.0 1 x Line out 1 x Display Port (4096x2160@60Hz)
- **Power Input** 24 V_{DC} ± 20%
- **Security** TPM 2.0 (built-in)

Environment

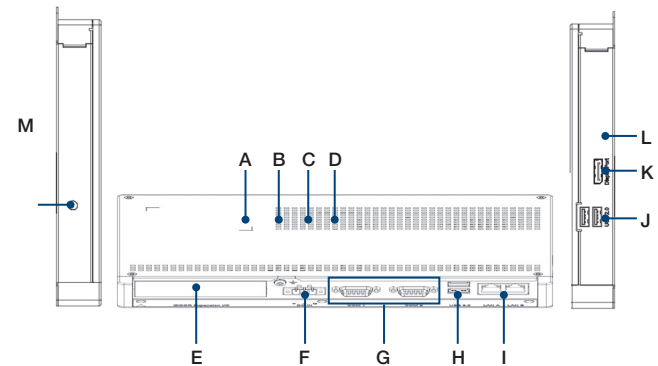
- **Humidity** 95% RH @ 40°C, non-condensing
- **Ingress Protection** IP66 (for optional panel module with "Panel Mount")
- **Operating Temperature** -20°C~60°C (Atom X6425E with SATA SSD) -20°C~55°C (Atom X6425E with NVMe SSD) 0°C~60°C (Celeron J6412 with SATA SSD) 0°C~55°C (Celeron J6412 with NVMe SSD)
- **Storage Temperature** -20°C~70°C

Power Consumption with Panel Module

Item	Power Consumption		Screen Size	Resolution	Luminance	Aspect Ratio
	Typ.	Max.				
TPC-B300	21W	50W	N/A	N/A	N/A	N/A
w/ FPM-D12T-BE	33W	62W	12.1"	1024x768	600nits	4:3
w/ FPM-D15T-BE	35W	64W	15"	1024x768	300nits	
w/ FPM-D17T-BE	45W	74W	17"	1280x1024	350nits	
w/ FPM-D15W-FBE	39W	68W	15.6"	1920x1080	450nits	16:9
w/ FPM-D18W-BE	33W	61W	18.5"	1366x768	450nits	
w/ FPM-D21W-BE	35W	64W	21.5"	1920x1080	250nits	
w/ FPM-D24W-BE	47W	76W	23.8"	1920x1080	350nits	

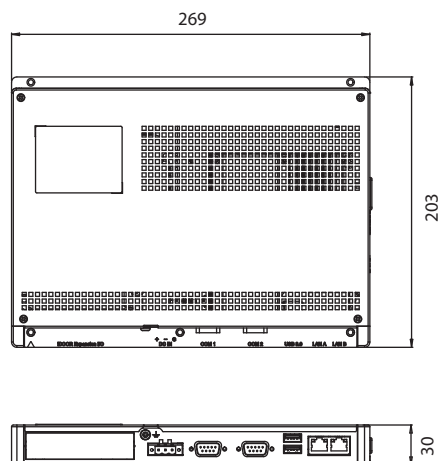
*Please find below the Ordering Information for the Panel Module.

Rear View



- A. 2.5" SSD/HDD slot
- B. mPCIe slot (iDoor module)
- C. M.2 M key 2280 (NVMe)
- D. M.2 AE Key 2230 (WiFi+BT)
- E. iDoor Slot
- F. Power Receptor
- G. RS-232/422/485x2
- H. USB3.2
- I. LAN
- J. USB3.2 + USB2.0
- K. Display Port (4096x2160 @ 60Hz)
- L. 1 x Line out
- M. Antenna opening

Dimensions



Unit: mm

Ordering Information

- **TPC-B300-J20A** TPC-B300 Box Module Celeron J6412 (10W)
- **TPC-B300-E20A** TPC-B300 Box Module Atom X6425E (12W)

Panel Module P/N	FPM-D12T-BE	FPM-D15T-BE	FPM-D17T-BE	FPM-D19T-BE	FPM-D15W-FBE	FPM-D18W-BE	FPM-D21W-BE	FPM-D24W-BE
Description	12.1" XGA TFT LED LCD	15" XGA TFT LED LCD	17" SXGA TFT LED LCD	19" SXGA TFT LED LCD	15.6" FHD TFT LED LCD	18.5" HD TFT LED LCD	21.5" FHD LED LCD	23.8" FHD TFT LED LCD

Note: Display modules **cannot** work independently. A computing box (TPC-B200/300/500/510/610) is compulsory to operate the display module.

Packing List

Item	Part No.	Depiction	Qty
Grounding cable	1703011001-11	A Cable G-TEM 4.3 100CM C=GR/Y	1
Plug-In Block	1652007930-01	Plug-In Block 1x3P/5.08mm/PA66/F/VA	1
Warranty	2190000902	CARDBOARD-WARRANTY REV. A2	1
BOX Fix Screw	1930000686	Screw M3x5L S/S D=5 H=1.3 (2+) ST Ni NK	5
iDoor Screw	1930002161	Screw M3x4.0(10.0)L R/S D=5.3 H=2.2+ ST BZn	2
HDD Screw	1930001361	Screw M3x4L S/S D=5 H=1.2 (2+) ST Ni NK	4
CPU Thermal Pad (Celeron J6412)	TBD	32X21X0.5 K=13	1
CPU Thermal Pad (Atom X6425E)	TBD	32X21X0.5 K=13	1
DDR Thermal Pad	1990021846N000	THERMAL PAD 59x19.5x1.0 K=6 GR-Hm SPC-1840WP	1
NVMe Thermal Pad	1990008165N010	Thermal pad 64x21.5x1.5mm K=2.5 GR25A-OHUNO-3282	1
M.2 Key-E Thermal Pad	1990035990N000	Thermal-Pad 22x22x1.5mm K=2.5 TP eApus-PG25A	1

Note: Any NVMe SSD with a built-in heatsink may cause interference with the TPC-B300's mechanism and thermal design. Therefore, please purchase an NVMe SSD without a built-in heatsink

Optional Accessories

Part Number	Description
AIW-166K3	6E AX210 (no.vpro), -40~85degree wireless kit
96PSA-A120W24T2-4	ADP A/D 100-240V 120W 24V C14 CORD END 62368
96PSA-A150W24T2-4	A/D 100-240V 150W 24V W/PFC C14 TERMINAL 62368
TPC-5000T-VMKE	TPC series wallmount kit from 12"-23.8"
1702002600 Power	cable (US) 1.8 M
1702002605 Power	cable (EU) 1.8 M
1702031801 Power	cable (UK) 1.8 M
1700000596 Power	cable (CN/AU) 1.8 M

Embedded OS

- **20701WX1ES0004** Img WIN10 LTSC V6.08 B059 TPC-B300 Entry

iDoor Modules

- **PCM-24D2R2-BE** Isolated RS-232, DB9 x 2, (USB type)
- **PCM-24D2R4-BE** Isolated RS-422/485, DB9 x 2, (USB type)
- **PCM-24D4R2-BE** Non-Isolated RS-232, DB37 x 1 (USB Type)
- **PCM-24D4R4-BE** Non-Isolated RS-422/485, DB37 x 1 (USB Type)
- **PCM-27D24DI-AE** Digital I/O, 16 DI / 8 DO, Isolation, DB37 x 1
- **PCM-24R2GL-AE** 2 Port Giga LAN Intel i350 PCIe mini card
- **PCM-24U2U3-BE** PCM-24U2U3, 2-Port USB 3.0, mPCIe
- **PCM-29R1TX-AE** 1-Port iLink(TX) long-distance display transmitter with RJ45
- **PCM-26D2CA-BE** SJA1000 CANBus, Lattice, CANOpen, DB9 x 2